

Approaches to Component Reliability in IEC Standards Development

NIST/UL Workshop on Photovoltaic Materials Durability

December 13, 2019

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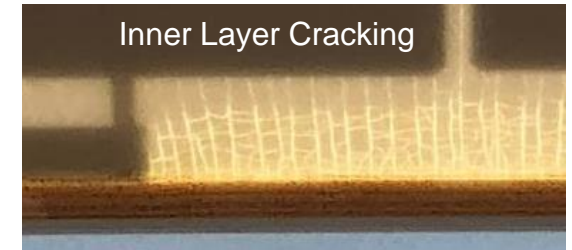


Problem statement:

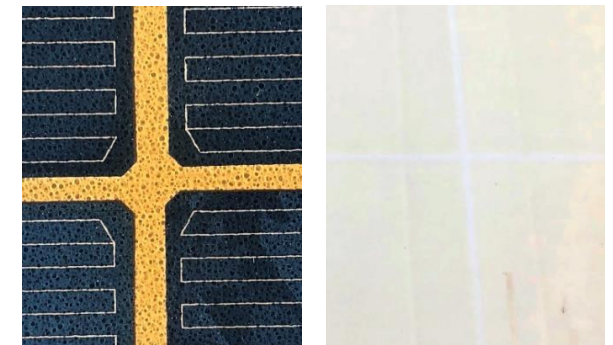
- Significant issues with degradation of polymeric materials observed with fielded modules
 - 61215/61730 testing does not address this issue well

Recognized:

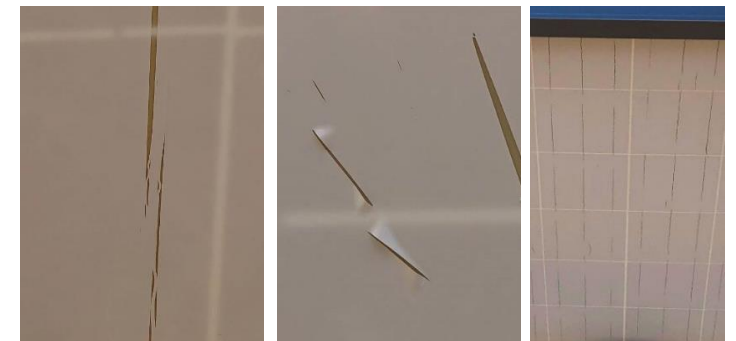
- Stress test methods not well established for very long durability analysis, relevant to target service life
- Multi-stress exposures (sequential or combi) are missing
- Some analyses better done at component level
- *Already too many test requirements...*
- Not enough known to select one “right” test set



Inner/Outer Layer Yellowing



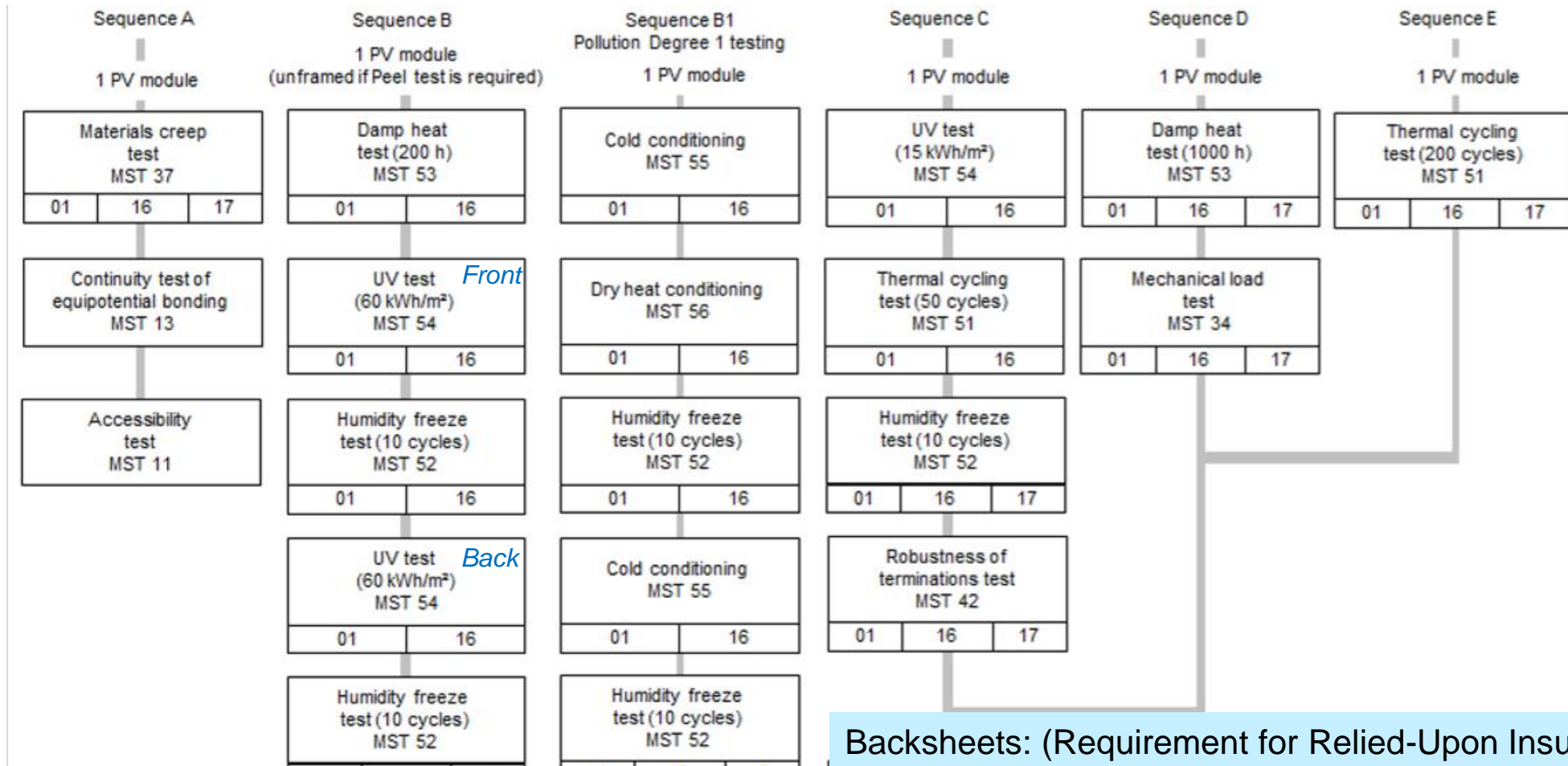
Outer Layer Cracking/Delam



Core Qualification Standards:

- **IEC 61730 PV module safety qualification**
- **IEC 61215 PV modules - Design qualification and type approval**

IEC 61730 Stress Testing



Backsheets: (Requirement for Relied-Upon Insulation)

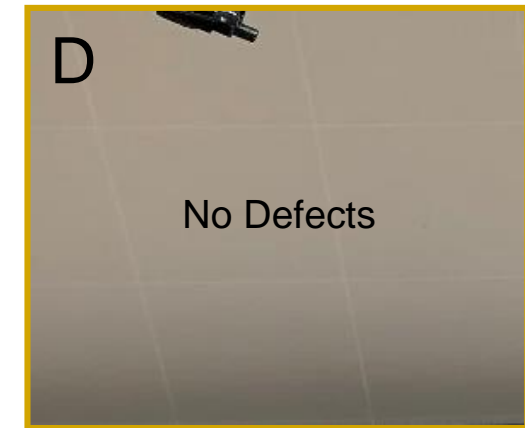
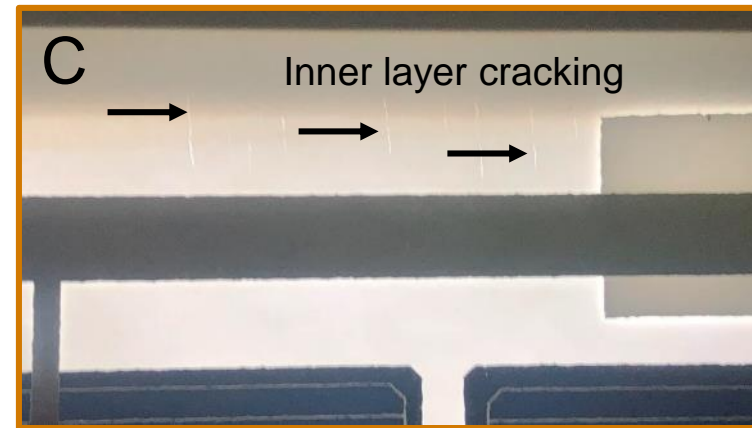
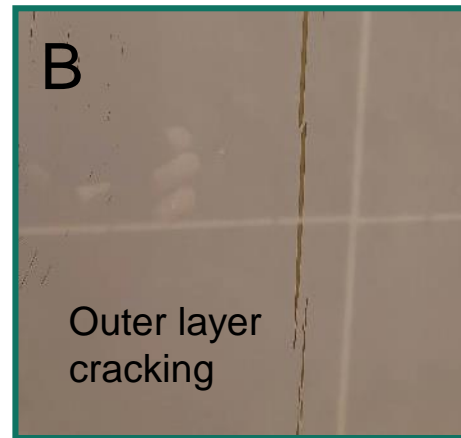
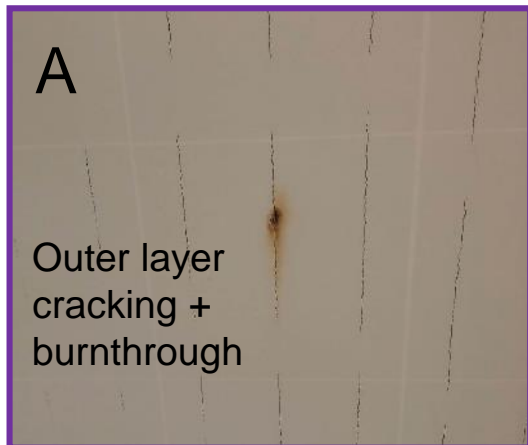
- RTE/RTI/TI>90C,
- minimum thickness
- Minimum BDVdc



Backsheet Defects in High Desert, SW USA

Total installation – single model number

- 100% BS cracking type A
- 100% BS cracking type B
- BS inner layer cracking type C
 - ~5% exhibited severe busbar corrosion
 - instances of electrical fires
- No obvious BS defects type D
- Encapsulant browning all modules



Core Qualification Standards:

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- IEC 61215 PV modules - Design qualification and type approval

Adding Component Testing:

IEC 62788 Series: Measurement procedures for materials used in photovoltaic modules

- 62788-1: Encapsulants
- 62788-2: Frontsheets and Backsheets
- 62788-5: Edge Seals
- 62788-7: Stress exposures

Components:

- IEC 62790 *Junction Boxes for PV modules*
- IEC 62852 *Connectors for DC-application in PV systems*
- IEC 62930 *Electric cables for PV systems.*



Post-stress evaluations in 62788-2 (Frontsheets/Backsheets)

UCF No.	Test Methods	Component evaluation Sheet Coupon Filtered Sheet	Package evaluation Coupon Minimodule	Fresh	1 000 h DH test	2 000 h UV (Xenon) exposure (4.10.3)	
					(4.10.2)	air side ^a	sun-facing side ^b
3	Tensile strength [MPa] (MD)	S, F	NA	✓	✓	✓	✓
	Tensile strength [MPa] (TD)			✓	✓	○	○
4	Elongation at break [%] (MD)			✓	✓	✓	✓
	Elongation at break [%] (TD)			✓	✓	○	○
5	Bond strength between layers of composition – or weakest link [N/mm] (for peelable layers)	S,F	NA	✓	✓	○	○
6	Bond strength between coatings or thin layers and film [rating scale] (for layers too thin or brittle to peel)	S,F	NA	✓	✓	○	–
7	Bond strength between a specific encapsulant and sheet [N/mm]	C	Coupon (BS/E) Minimodule (E/Cell)	○	○	○	○
8	Bond strength between a specific JBox adhesive and BS (N/mm)		Refer to IEC 62790	○	IEC 62790	–	–
12	dc breakdown voltage [kV]			✓	○	○	○
15	Visual inspection			✓	✓	✓	✓
16	Solar transmittance (for transmittive sheet only)			✓	○	○	○
17	Solar reflectance c(for reflective sheets only)			✓ (sun-facing)	○ (sun-facing)	–	○
18	Yellowness index DYI c			○	○	○	○
19	CIE L*a*b* (D65/10°) c			○	○	○	○
20	Specular gloss c			○	○	○	○

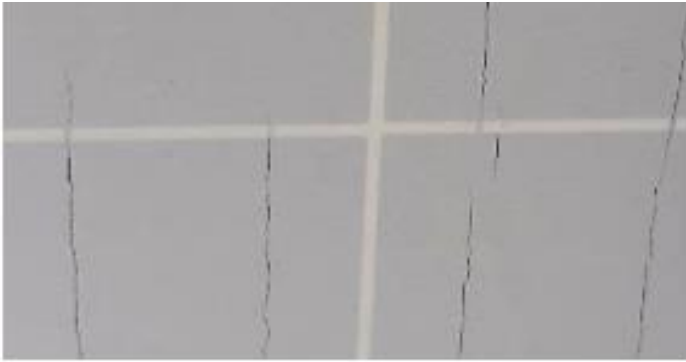


Core Qualification Standards:

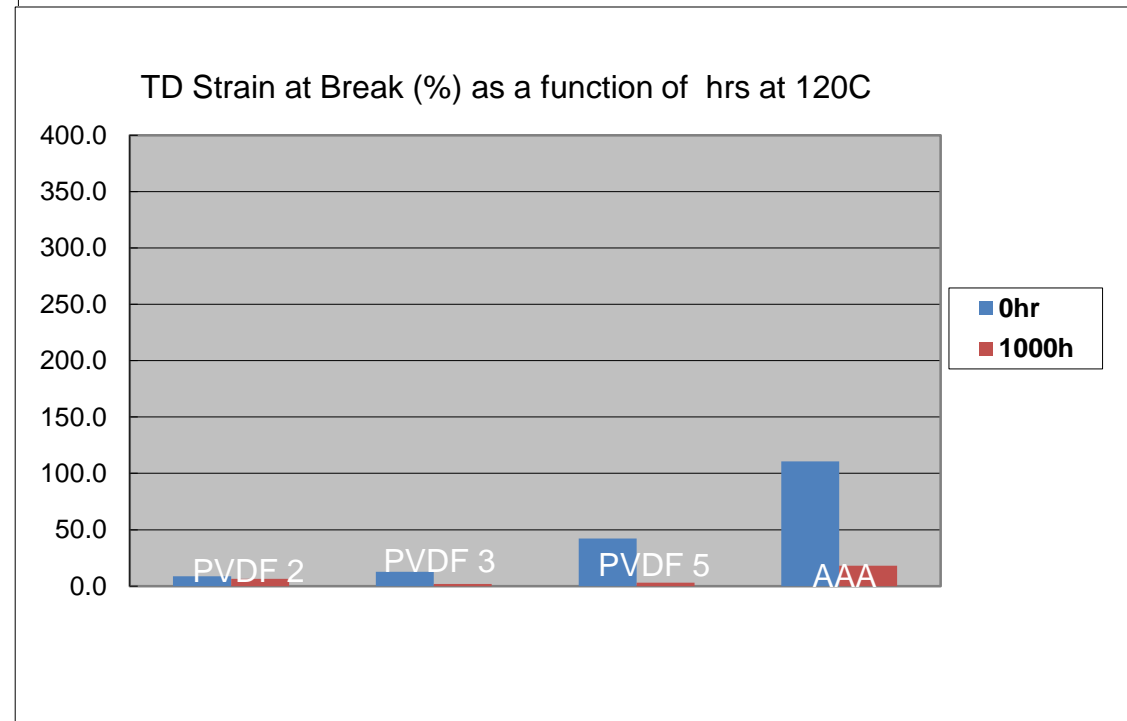
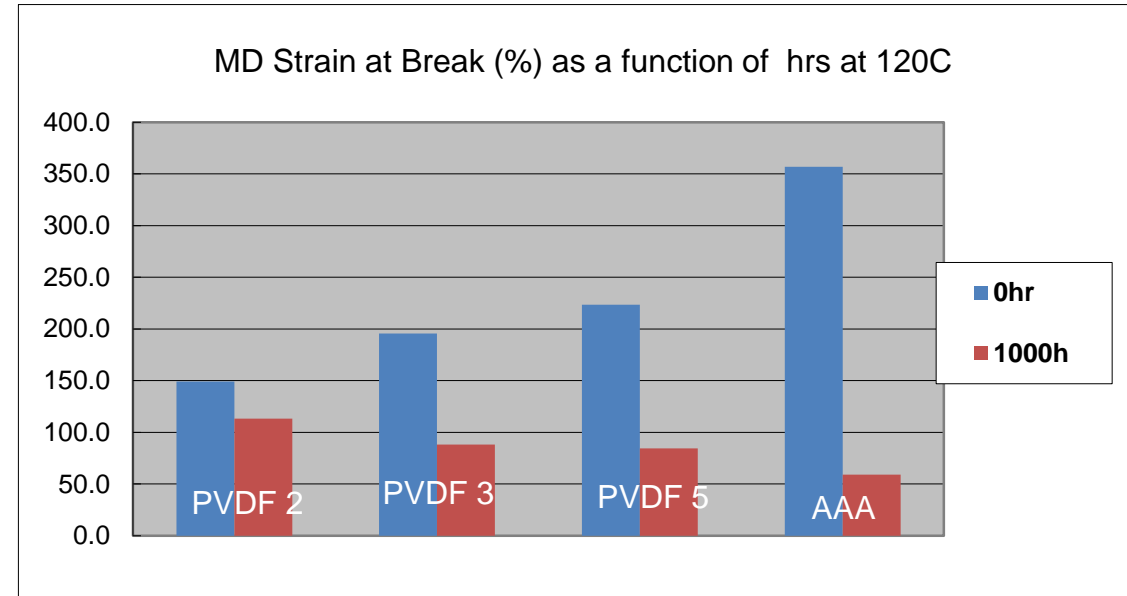
- IEC 61215 PV modules - Design qualification and type approval
- IEC 61730 PV module safety qualification

IEC 61730 AMD1

- Will include requirements for component pre-qualifications:
 - **IEC 62788-2-1 Safety Requirements for Frontsheets and backsheets**
 - IEC 62790 *Junction Boxes for PV modules*
 - IEC 62852 *Connectors for DC-application in PV systems*
 - IEC 62930 *Electric cables for PV systems*).



No significant change in tensile strength after oven aging



Alignment pre-CD 62788-2-1 with 61730-1 & -2

Backsheet constructions and Relied-Upon Insulation (RUI)

- Update figure with layer stack schematics from 61730-1 AM1

a) Single-layer	
a1) Single monolithic layer	a2) Single combined layer
<p>Thickness (e.g. > 150 μm for 1 000 V)</p>	<p>Thickness (e.g. > 150 μm for 1 000 V)</p>
<p>Pass, if layer A fulfils the requirements of 5.3.2 a) for single layer reinforced insulation and distance through insulation.</p>	<p>Pass, if co-extruded combined single layer $A_1A_2...A_n$ fulfils the requirements of 5.3.2 a) for reinforced insulation and distance through insulation.</p>

b) Multi-layer		
b1) Multi-layer without auxiliary layers	b2) Multi-layer with non-RUI polymeric layers "x"	b3) Multi-layer with conductive layer
<p>Thickness (e.g. > 150 μm for 1 000 V)</p>	<p>Thickness (e.g. > 150 μm for 1 000 V excl. "x")</p>	<p>Thickness (e.g. > 150 μm for 1 000 V)</p>
<p>Pass, if each layer A and B fulfil the requirements of 5.3.2 b) for basic insulation and the combined multilayer fulfils the requirements of 5.3.2 b) for reinforced insulation and distance through insulation.</p>	<p>Pass, if each layer A and B fulfil the requirements of 5.3.2 b) for basic insulation and the combined multilayer fulfils the requirements of 5.3.2 b) for reinforced insulation and distance through insulation excluding the "x" layer(s).</p>	<p>Pass, if layer C fulfils the requirements of any of a1), a2), b1) or b2), excluding the conductive layers and excluding all layers above conductive layer in direction of air-side.</p>

IEC 62788-2-1 Safety Requirements, Frontsheets and Backsheets

Test Matrix

No.	Test name	Clause	final product (unexposed)	1000 h DH test clause 5.9.2 FBST 08	2000 h UV test clause 5.9.3 FBST 09
FBST 01	Visual inspection	5.2	YES (r, s)	YES	YES
FBST 02	Dimensions and tolerances [μm]	5.3	YES (r, s)	—	—
FBST 03	Distance through insulation [μm]	5.4	YES	—	—
FBST 04	TI or RTE (RTI) [$^{\circ}\text{C}$] and thermal failsafe test (Elongation at break)	5.5	YES*	—	—
FBST 05	CTI test	5.6	YES	—	—
FBST 06	DC breakdown voltage	5.7	YES (s)	YES	YES
FBST 07	Tensile strength [MPa]	5.8	YES (s)	YES	YES
FBST 07	Elongation at break [%]	5.8	YES (s)	YES	YES

Note:

)* For FBST 04, tests are conducted on single layers, not on final product.

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IEC 61730 AMD1

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Beyond qualification

- **IEC 63126**: Testing for High T applications
- **IEC 63209**: Extended testing of PV module for risk analysis
 - Part 1: Modules
 - Part 2: Durability characterization of polymeric component materials and packaging sets



IEC 63126: Testing for High T Applications

Standard	Test Ref	Test Name	Original Requirement	Proposal - Level 1	Proposal - Level 2	
			$T_{98\%} = 70\text{ °C}$ or less	$T_{98\%} > 70\text{ °C}$ to $\leq 80\text{ °C}$	$T_{98\%} > 80\text{ °C}$ to $\leq 90\text{ °C}$	
module level tests						
IEC 61215	MQT 09	Hot-spot endurance test	$(50 \pm 10)\text{ °C}$	+10 °C, $(60 \pm 10)\text{ °C}$	+20 °C, $(70 \pm 10)\text{ °C}$	
	MQT 10	UV preconditioning	$(60 \pm 5)\text{ °C}$	+10 °C, $(70 \pm 5)\text{ °C}$	+20 °C, $(80 \pm 5)\text{ °C}$	
	MQT 11	Thermal cycling test	$(85 \pm 2)\text{ °C}$	+10 °C, $(95 \pm 2)\text{ °C}$	+20 °C, $(105 \pm 2)\text{ °C}$	
	MQT 18	Bypass diode testing chamber	Part 1	I_{SC}	$1.15 * I_{SC}$ for diode T	$1.15 * I_{SC}$ for diode T
			Part 2	$1.25 * I_{SC}$	$1.4 * I_{SC}$ for stress	$1.4 * I_{SC}$ for stress
IEC 61730		RTI/RTE/TI	min RTI 90 °C	min RTI 100 °C	min RTI 110 °C	
	MST 22	Hot spot endurance	$(50 \pm 10)\text{ °C}$	+10 °C, $(60 \pm 10)\text{ °C}$	+20 °C, $(70 \pm 10)\text{ °C}$	
	MST 37	Material creep test	105 °C	no change	110 °C	
	MST 51	Thermal cycle	$(85 \pm 2)\text{ °C}$	+10 °C, $(95 \pm 2)\text{ °C}$	+20 °C, $(105 \pm 2)\text{ °C}$	
	MST 54	UV test	$(60 \pm 5)\text{ °C}$	+10 °C, $(70 \pm 5)\text{ °C}$	+20 °C, $(80 \pm 5)\text{ °C}$	
	MST 56	Dry heat conditioning	105 °C	no change	110 °C	
component level tests						
IEC 62788-1-7 (encapsulant, performance)	8	Optical durability encapsulants	IEC TS 62788-7-2 (A3 cond.)	IEC TS 62788-7-2 (A4 cond.)	IEC TS 62788-7-2 (A5 cond.)	
IEC TS 62788-2* (backsheet and frontsheet safety)	4.10.3	Weathering (UV) ageing test	IEC TS 62788-7-2 (A3 cond.)	IEC TS 62788-7-2 (A4 cond.)	IEC TS 62788-7-2 (A5 cond.)	
IEC 62852		Marking, Upper Limit Temperature (ULT)	no requirement	95 °C	105 °C	
IEC 62790		Range of temperature (upper ambient temperature)	no requirement	95 °C	105 °C	

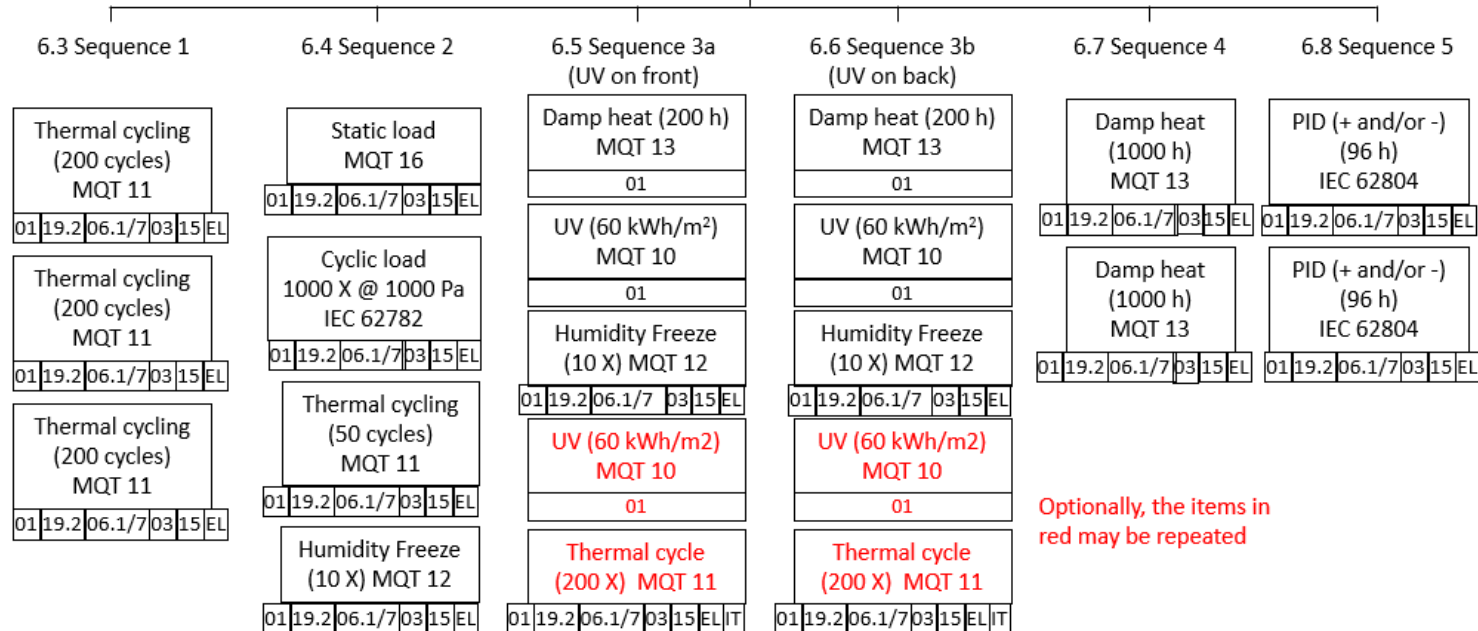
* - Following publication of IEC 62788-2-1, this standard will take the place of IEC TS 62788-2 and the test reference will be FBST 09. Pass/fail requirement from IEC 62788-2-1 shall be followed.

63209 Extended testing of PV module for risk analysis

Part 1 – Modules

5.2 Physical measurement
5.3 Visual inspection – IEC 61215 MQT 01
5.4 Initial stabilization – IEC 61215 MQT 19.1
5.5 Performance at STC – IEC 61215 MQT 06.1 & 07
5.6 Insulation test – IEC 61215 MQT 03
5.7 Wet leakage test – IEC 61215 MQT 15
5.8 EL imaging – IEC 60904-13 (I_{sc} , $0.1X I_{sc}$)
5.9 Insulation thickness test – IEC 61730 MST 04*

There is a general consensus that for extended UV exposures, it is more practical to test at the component or mini-module level than with full size modules... Users of extended test data are encouraged to use extended coupon or mini-module tests to evaluate individual polymer components, and specific combinations of polymeric components



Optionally, the items in red may be repeated



IEC 63209 Part 2:

Durability characterization of polymeric component materials and packaging sets

Data for risk analysis some combination of test data from:

A. Component specific testing

B. BOM specific coupon testing

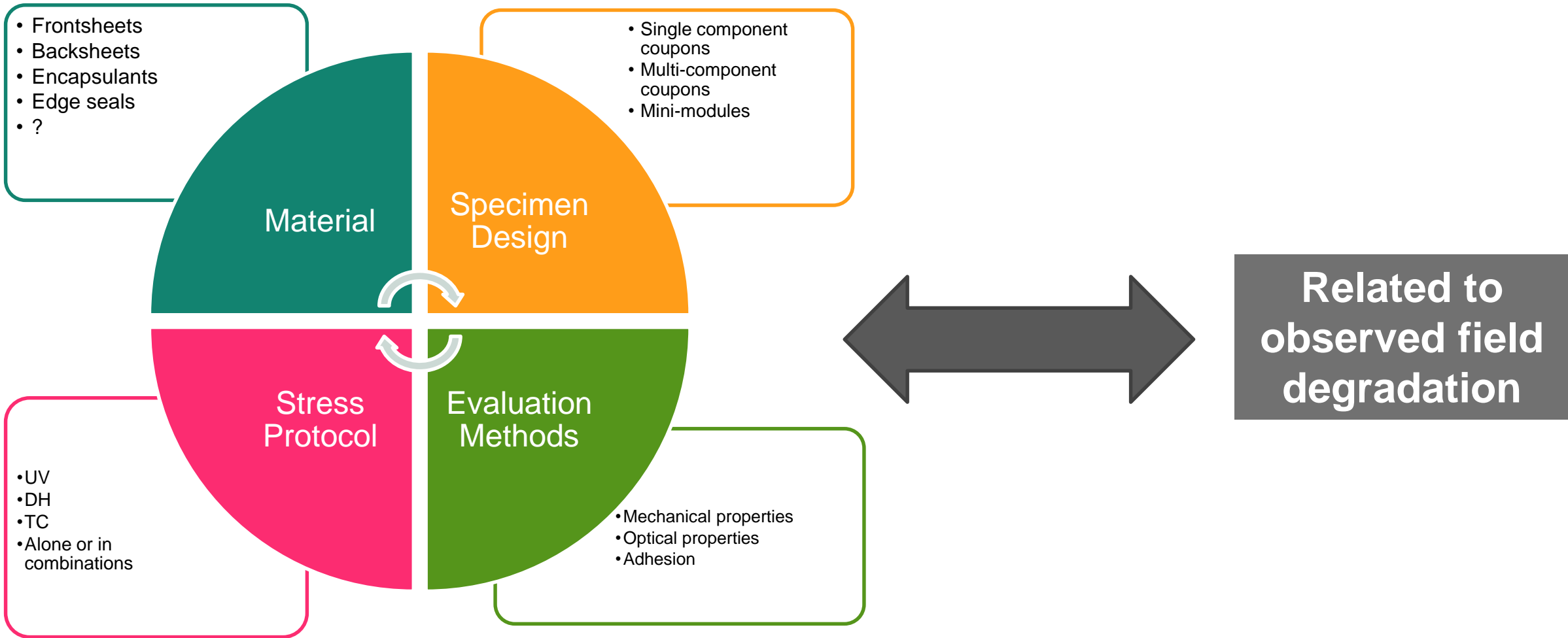
C. Minimodule AND/OR “structured coupon” testing

➤ **All possible tests for all different specimens is too much!**

➤ Need to determine a set which allows for good analysis



Considerations

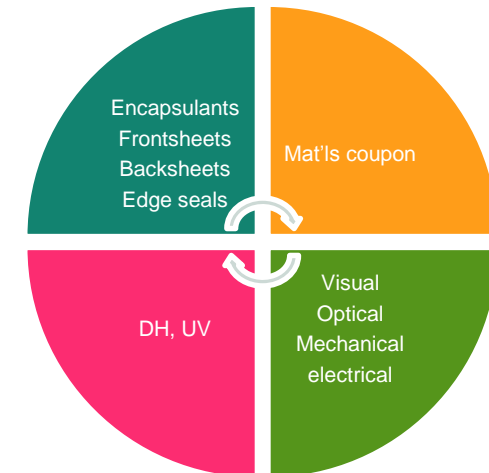


I. Component level testing

- Utilizes test methods established in 62788 series (and Jbox, Connectors and Cables standards)
- Evaluation tests and specimen designs described in standards
- UV Stress exposures from 62788-7-2
 - Longer exposures to be included

	polymeric frontsheet/backsheet			encapsulant	
stress:	DH	UV front (A3)	UV back (A3)	DH	UV
duration	1000 h	2000 h, 4000 h Optional: additional increments of 4000 h, up to 16000 h	2000 h, 4000 h	1000 h	4000 h Optional: additional increments of 4000 h, up to 16000 h
targeted failure modes	- changes to key materials properties (potential early indicators); - maintenance of key properties above minimum values				
tests:	- color - tensile - Vdc BDV (opt) - adhesion within the BS/FS			- transmission - adhesion to glass	

Test duration - Place holder for discussions

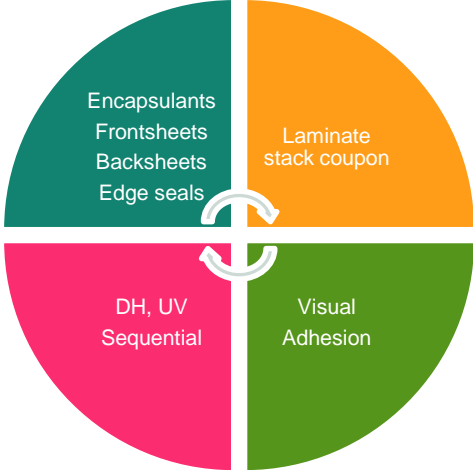


II – Polymeric packaging materials (specific BOM)

	materials stack coupon				
stress:	DH	UV front (A3)	UV back (A3)	Frontside Sequential	Backside Sequential
duration	1000 h	2000 h, 4000 h Optional: additional increments of 4000 h, up to 16000 h	2000 h 4000 h	Sequential Testing (TBD) w/ long UV exposure)	Sequential Testing, including UV, DH, TC - suggest MAST = DH/UV/TC/UV/TC/UV
targeted failure modes	<ul style="list-style-type: none"> - loss of adhesion - changes in key material properties 				
tests:	<ul style="list-style-type: none"> - visual (color, delam) - adhesion <ul style="list-style-type: none"> - glass to encapsulant - encapsulant to backsheet - other? 				

Adding combination stress exposures

- Place holder for discussions:
- Exposure duration
 - Sequential testing -

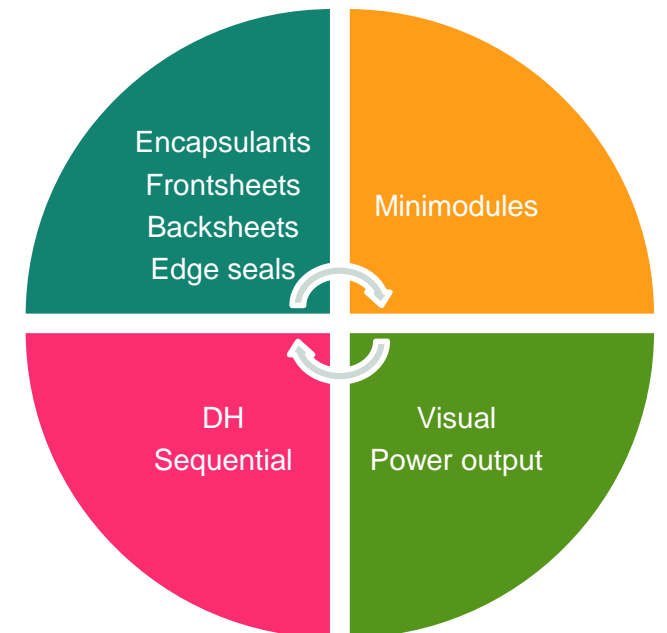


III – Minimodules (specific BOM)

	Materials stack w/ cells/wiring		
stress:	DH	Frontside Sequential Testing	Backside Sequential Testing, including UV, DH, TC - suggest MAST
duration	1000h	TBD, include long UV exposure	DH 1000 UV1000 3 x (TC200 + UV1000)
targeted failure modes	delamination backsheet cracks		
tests:	visual (color, cracks, delamination bubbles...) power output ?		

Adding stresses:

- 3D structure
- Voltage



Anticipated: multi-step approach

❖ Multiple components, multiple module designs can be considered – not all at once

➤ *Expect this may take multiple Parts*

❖ Path forward:

1. Review of 62788 Series, Jbox, Connector and Cable standards
 - Consolidate exposures and testing into one document for “Risk Analysis” with 63209-1 data
 - Consider extended sequences
 - Consider new sequences (*if easily agreed*)
2. Project Team to identify biggest gaps, and focus efforts; options:
 - Combined stress sequences
 - Adhesion testing
 - BOM-specific testing
 - Consider extended sequences
3. Parallel test plans to help identify useful combinations of testing

Test Plan Sets

		Solder Bump Coupon A3 exposures + TC		Flat Coupon A3 exposures			63209 front- side seq	63209 back side seq
specimen		FS coupon+	BS coupon+	FS laminate	FS trm	BS film	1-cell m-mod	full size modules
mat'l orientation		MD and TD		TD only			MD (aligned to ribbon dir.)	
Post-stress test		visual	visual	visual	visual tensile	visual tensile	visual	visual
<u>BS</u>	<u>prior observations</u>							
PET1	front side cracking reduction of %E	x	x	x	x	x	x	z
PET2	yellowing, fs cracking	x	x	x	x	x	x	
PVDF1	back side cracking	x	x		x	x		
PVDF2	back side cracking	x	x		x	x		x
PVDF3	unknown	x	x		x	x		
TPT	known good	x	x	x	x	x	x	
TPE	known good							x
AAA	fs and bs cracking	x	x	x	x	x	x	x
FEVE	front side cracking	x					x	





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